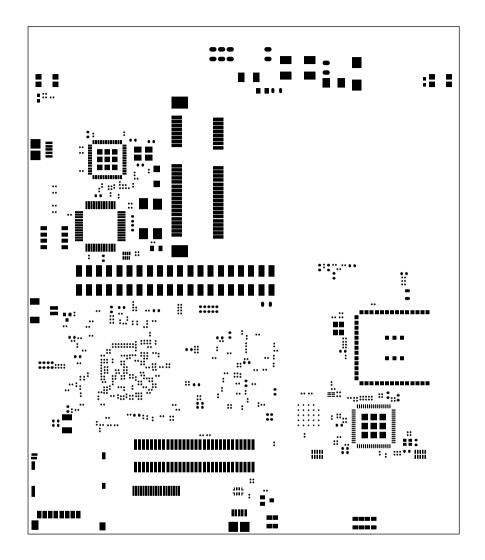
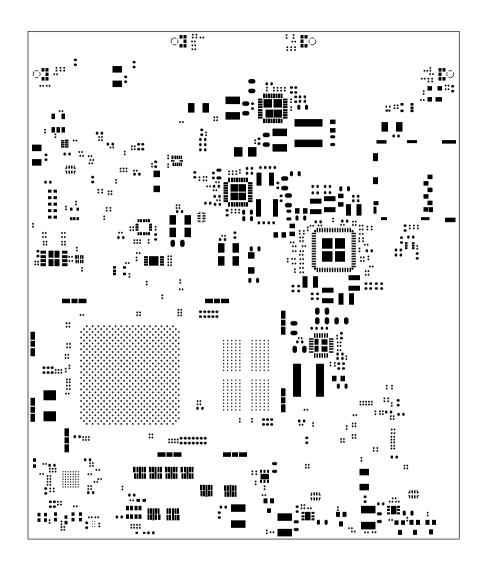


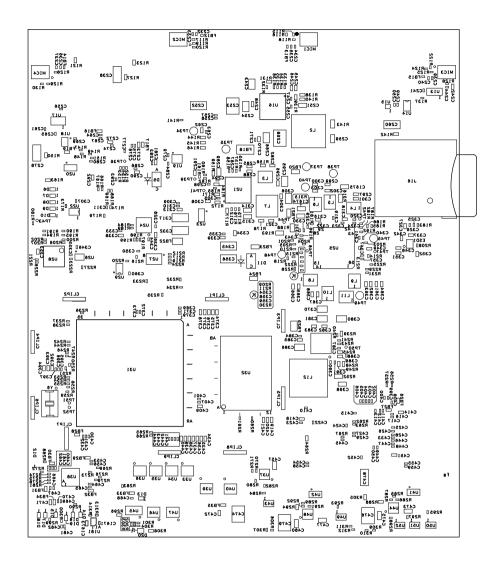
e I NFOCH I PS	
DATE: 30/04/2019	
DESIGNED AT: eINFOCHIPS	
PART NO/CARD REF: ARROW IMX8XML RD BOARD	REV:3.0
FILM LAYER : ASSEMBLY PRIMARY SIDE	



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PART NO/CARD REF:ARROW_IMX8XML_RD BOARD	REV:3.0
FILM LAYER : SOLDERPASTE PRIMARY SIDE	



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DATE: 30/04/2019	
DESIGNED AT: eINFOCHIPS	
PART NO/CARD REF:ARROW_IMX8XML_RD BOARD	REV:3.0
FILM LAYER : SOLDERPASTE SECONDARY SIDE	



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FILM LAYER : ASSEMBLY SECONDARY SIDE	